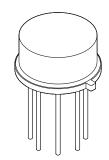


HIGH SPEED OPERATIONAL AMPLIFIER

0024

FEATURES:

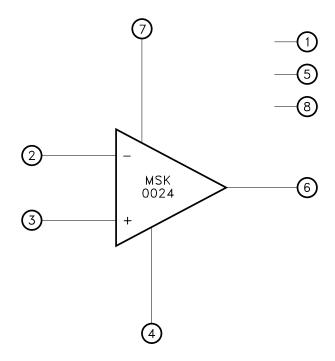
- · Pin Similar Replacement for LH0024
- High Slew Rate: 400V/µS Typ.
- · Fast Settling Time
- · Excellent DC Performance
- · Excellent Video Specifications
- Internally Compensated for Unity Gain Operation



DESCRIPTION:

The MSK 0024 is a wide bandwidth, high slew rate operational amplifier ideally suited for use as a buffer to A to D and D to A converters and high speed comparators. The device is internally compensated and will remain stable when driving a capacitive load. The MSK 0024 is also a pin similar replacement for the popular LH0024. The MSK 0024 is internally compensated and can replace the LH0024 in most applications without any changes to existing circuitry. The device is packaged in a hermetically sealed 8 pin metal can.

EQUIVALENT SCHEMATIC



TYPICAL APPLICATIONS

- · High Speed DAC Buffer
- High Speed Flash ADC Buffer
- · High Speed Cable Driver
- Imaging Equipment

PIN-OUT INFORMATION

1 NC 5 NC 2 -Input 6 Output 3 +Input 7 +Vcc 4 -Vcc 8 NC

ABSOLUTE MAXIMUM RATINGS

Vcc	Supply Voltage ±18V	Tst Storage Temperature Range65°C to +150°C
P_D	Internal Power Dissipation 600mW	T _{LD} Lead Temperature Range 300°C
V_{IN}	Input Voltage ±Vcc ≤ ±15V	(10 Seconds)
V_{IND}	Differential Input Voltage 6V	T _J Junction Temperature 175°C
Tc	Case Operating Temperature Range	
	MSK0024H/E55°C to +125°C	
	MSK002440°C to +85°C	

ELECTRICAL SPECIFICATIONS

Parameter	Test Conditions	Group A	MSK0024H/E			MSK0024			Units
Parameter	Test Conditions	Subgroup	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
STATIC									
Supply Voltage Range (2)		-	±5	±15	±18	±5	±15	±18	V
Quiescent Current			-	±6	±15	-	±6	±18	mA
Quiescent Current	2, 3	-	±6	±15	-	-	-	mA	
INPUT									
Input Offset Voltage	AV = 5 RS = 50Ω	1	-	±0.5	±3.0	-	±0.5	±4.0	mV
Input Offset Voltage		2, 3	-	±1.0	±5.0	-	-	-	mV
Input Offset Voltage Drift (2)		-	-	±15	-	-	±15	-	μV/°C
Input Bias Current (2)	Vcm = 0V	1	-	±4	±20	-	±4	±30	μΑ
input bias Current (2)		2, 3	-	±5	±30	-	-	-	μA
Input Offset Current (2)	Vcm = 0V	1	-	±1	±5	-	±1	±10	μA
input Oliset Guirent (2)		2, 3	-	±1	±5	-	-	-	μΑ
Common Mode Rejection Ratio (2)	$V_{CM} = \pm 10 V_{DC}$	1	75	95	-	75	95	-	dB
Power Supply Rejection Ratio (2)	-Vcc = -15V +Vcc = +5V to +15V +Vcc = +15V -Vcc = -5V to -15V	1	75	95	-	75	95	-	dB
Input Impedence (2)		-	-	300	-	-	300	-	ΚΩ
Input Capacitance (2)		-	-	1.5	-	-	1.5	-	pF
OUTPUT									
Output Voltage Swing	RL = 2KΩ	4	±12.0	±12.5	-	±12.0	±12.5	-	V
Power Bandwidth (2)	Vout = ± 10 Vpk RL = 2 K Ω	-	-	4.5	-	-	4.5	-	MHz
TRANSFER CHARACTERISTICS				•					
Slew Rate (7)	Vout = ± 10 Vpk RL = 2 K Ω	4	220	400	-	200	400	-	V/µS
Open Loop Voltage Gain (2)	Vout = ± 10 Vpk f = 10 Hz	4	3	8	-	3	8	-	V/mV

NOTES:

- 1) Unless otherwise specified, Vcc = ±15Vpc and Vin = 0V.
- (2) Guaranteed by design but not tested. Typical parameters are representative of actual device performance but are for reference only.
- (3) Industrial grade and "E" suffix devices shall be tested to subgroups 1 and 4 unless otherwise requested.
- (4) Military grade devices ("H" suffix) shall be 100% tested to subgroups 1, 2, 3 and 4.
- (5) Subgroup 5 and 6 testing available upon request.
- 6 Subgroup 1, 4 Tc = +25°C Subgroup 2, 5 Tc = +125°C

Subgroup 3, 6 $T_A = -55^{\circ}C$

(7) Slew rate is measured on rising edge.

APPLICATION NOTES

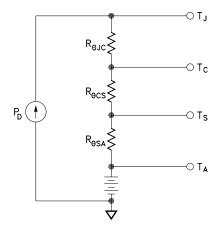
POWER SUPPLY BYPASSING

Both the negative and positive power supplies must be effectively decoupled with a high and low frequency bypass circuit to avoid power supply induced oscillation. An effective decoupling scheme consists of a 0.1 microfarad ceramic capacitor in parallel with a 4.7 microfarad tantalum capacitor from each power supply pin to ground.

HEAT SINKING

To determine if a heat sink is necessary for your application and if so, what type, refer to the thermal model and governing equation below.

Thermal Model:



Governing Equation:

 $T_J = P_D X (R_{\theta JC} + R_{\theta CS} + R_{\theta SA}) + T_A$

Where:

TJ = Junction Temperature
PD = Total Power Dissipation

 $R_{\theta JC}$ = Junction to Case Thermal Resistance $R_{\theta CS}$ = Case to Heat Sink Thermal Resistance $R_{\theta SA}$ = Heat Sink to Ambient Thermal Resistance

TC = Case Temperature
TA = Ambient Temperature
TS = Sink Temperature

Example:

The example demonstrates a worst case analysis for the op-amp output stage. This occurs when the output voltage is 1/2 the power supply voltage. Under this condition, maximum power transfer occurs and the output is under maximum stress.

Conditions:

Vcc = ± 16 VDC Vout = ± 8 Vp Sine Wave, Freq. = 1KHz RL = 200Ω For a worst case analysis we treat the +8Vp sine wave as an 8 VDC output voltage.

1.) Find driver power dissipation

 $P_D = (VCC-VOUT) (VOUT/RL)$

 $= (16V-8V) (8V/200\Omega)$

= 320mW

2.) For conservative design, set $T_J = +125$ °C.

3.) For this example, worst case $TA = +100^{\circ}C$.

4.) ReJC = 58°C/W from MSK 032B Data Sheet.

5.) Recs = 0.15°C/W for most thermal greases.

6.) Rearrange governing equation to solve for Resa:

 $R_{\theta}SA = ((T_J - T_A) / P_D) - (R_{\theta}JC) - (R_{\theta}CS)$

 $= (125^{\circ}\text{C} - 100^{\circ}\text{C})/0.32\text{W} - 58^{\circ}\text{C/W} - 0.15^{\circ}\text{C/W}$

= 78.1 - 58.15

= 19.9°C/W

The heat sink in this example must have a thermal resistance of no more than 19.9°C/W to maintain a junction temperature of less than +125°C.

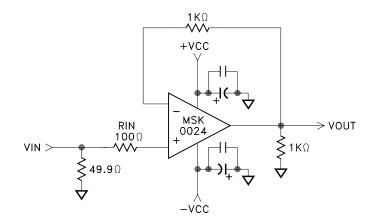
INPUT CONSIDERATIONS

An input resistor (RIN below) is required in circuits where the input to the MSK0024 will be subjected to transient or continuous voltages exceeding the ±6V maximum differential limit. This resistor will limit the current that can be forced into the bases of the input transistors.

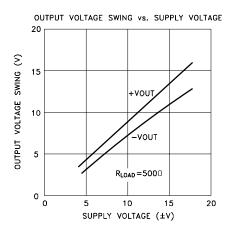
FEEDBACK RESISTORS

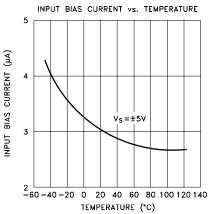
Feedback resistors should be of low enough value (<5K recommended) to ensure that the time constant formed with the capacitance at the summing junction will not limit amplifier performance. If a larger resistor must be used, a small (< 10pF) feedback capacitor may be used in parallel with the feedback resistor to compensate and optimize the performance of the MSK0024.

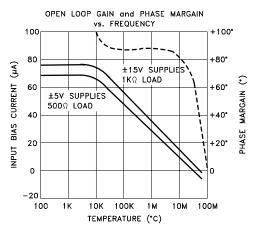
TYPICAL APPLICATION CIRCUIT

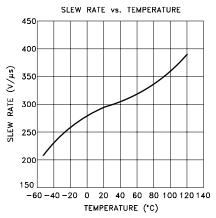


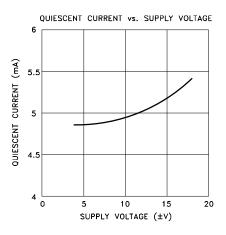
TYPICAL PERFORMANCE CURVES

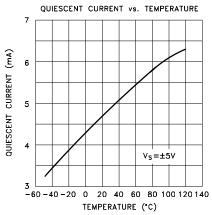


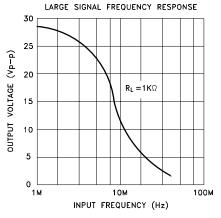


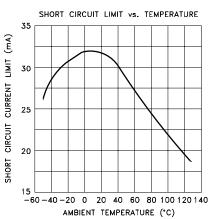




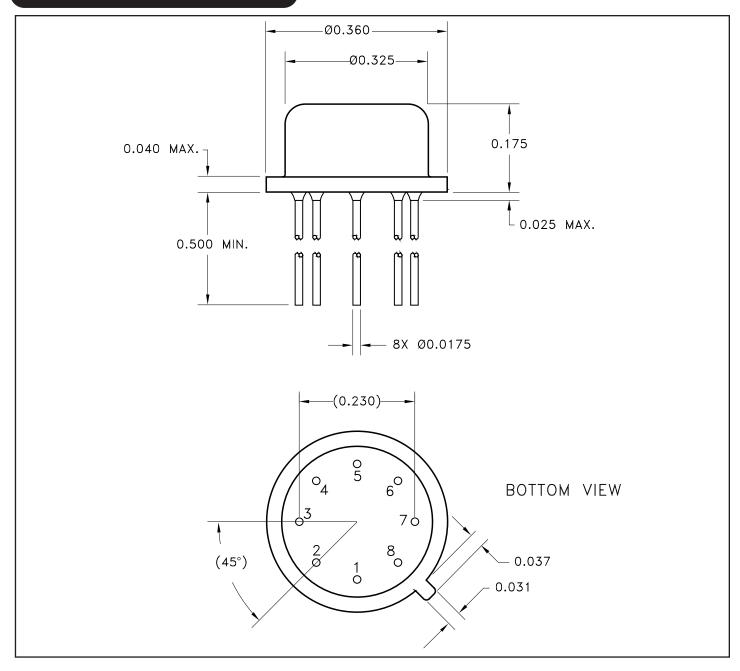






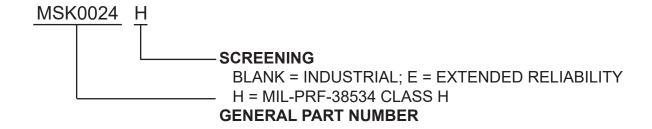


MECHANICAL SPECIFICATIONS



ALL DIMENSIONS ARE ±0.010 INCHES UNLESS OTHERWISE LABELED.

ORDERING INFORMATION



The above example is a Military grade hybrid.

REVISION HISTORY

REV	STATUS	DATE	DESCRIPTION	
Α	Released	03/03	Initial Release	
В	Released	01/24	Add note to slew rate parameter in electrical specifications table.	

TTM Technologies

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